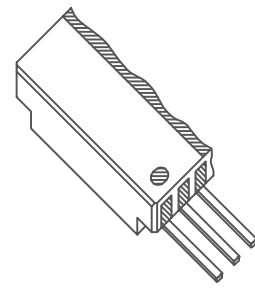
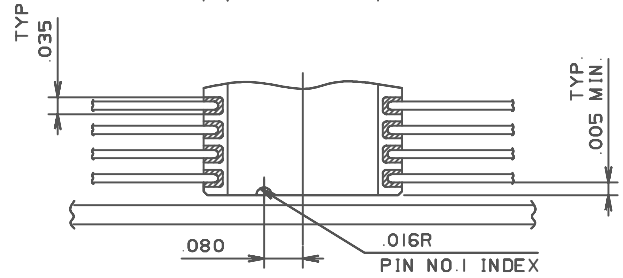


- NOTES
1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
 2. SEAL AREA TO BE METALLIZED.
 3. DIE ATTACH AREA TO BE METALLIZED.
 4. SEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.



CHAMFER DETAIL



MODIFICATION		DATE		DRAWN		CHECKED		APPROVED		DATE	
△	REDRAWN	JUN.25.90	S.SE	S.T	T.A	M.K					JUN.25.90
△	REDRAWN	JUN.5.90	S.SE	S.T	T.A	M.K					
		CHANGED		DATE		DRAWN		CHECKED		APPROVED	
				NAME		SCALE		MATERIAL		TOLERANCE	
				32 LEAD FLAT PACKAGE		5/1		AS INDICATED		±.005	
				DRAWING NO.		KYOCERA CORPORATION		KYOTO JAPAN		KD-F90148-B	
				SHEET		1/4					

FB032Y148-2 S=0 D=0

